

November 11-13, 2022 | Shenzhen, China

## CONFERENCE INTRODUCTION

<http://www.apccas2022.org/cfss.html>

The IEEE Asia Pacific Conference on Circuits and Systems (APCCAS) is the regional flagship conference of the IEEE Circuits and Systems Society in Asia. APCCAS 2022 will be held in Shenzhen, China during November 11-13, 2022. Shenzhen is the electronics R&D world center with more than 300 global or regional centers from Fortune Global 500 companies. Besides, Shenzhen is also suitable for tourism, which is ranked No. 2 in the list of best cities for travel by Lonely Planet.

## SPECIAL SESSION ON

Session Title	RF/mmW/Sub-THz Circuits and Systems
Special Session Organizer	Shunli Ma, Fudan University

## ABSTRACT

RF/mmW/Sub-THz circuits and systems are emerging techniques for 6G communication and RF phase array radar. These phase array chip consists of several key building blocks, such as a power amplifier, low noise amplifier, phase shifter, and so on. This session covers RF/mmW/Sub-THz Circuits designs implemented using CMOS, GaAs, and GaN technology with improved performance and energy efficiency.

## IMPORTANT DATES

Submission of Special Session Full Papers

August 6, 2022

## PUBLICATION

Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. Selected papers will be invited to submit extended full papers to IEEE Transaction on Circuits and Systems I (TCAS-I), IEEE Transaction on Circuits and Systems II (TCAS-II) and IEEE Open Journal of Circuits and Systems (OJCAS).

## SUBMISSION METHOD



Papers for publication must be submitted in full paper electronically. All edition and update must be done up until the submission deadline. Papers submitted to APCCAS Conference will undergo a double-blind review process. Submissions must have all details identifying the author(s) removed from the original manuscript (including authors' names, affiliations, acknowledgments and other related personal information).

Please make sure to use the standard IEEE conference templates to prepare your final manuscript, which can be found through link:

<https://www.ieee.org/content/dam/ieee-org/ieee/web/org/conferences/conference-template-a4.docx>



## SUBMISSION LINK

<http://www.easychair.org/conferences/?conf=apccas2022>

Sponsored by



Hosted by



Co-sponsored by



深圳大学  
SHENZHEN UNIVERSITY



清华大学深圳国际研究生院  
Tsinghua Shenzhen International Graduate School



北京大学深圳研究生院  
Peking University Shenzhen Graduate School

## CONTACT

Tel.: +86-28-87555888 Mob.: +86-13688349945 Email: [info@apccas2022.org](mailto:info@apccas2022.org)